

**AMENDMENTS TO THE CLAIMS**

The following is a complete, marked up listing of revised claims with a status identifier in parentheses, underlined text indicating insertions, and strikethrough and/or double brackets indicating deletions.

**Listing of the Claims**

1. (CURRENTLY AMENDED) A DNA chip, comprising:
  - a flat carrier; and
  - an array of spots containing catcher molecules, each spot being assigned a microelectrode arrangement for detecting binding events between the catcher molecules and target molecules applied via an analyte solution, the electrode arrangement being at least partially embedded in a hydrophilic reaction layer which is permeable to target molecules and in which immobilized catcher molecules are distributed three-dimensionally,
    - the hydrophilic reaction layer having a thickness approximately in the range of  $1L$  to  $5L$ ,  $L$  being the sum of electrode width and electrode spacing,
    - the electrode width and the electrode spacing being approximately  $1\mu\text{m}$ , and
    - the hydrophilic reaction layer having a thickness between  $2\mu\text{m}$  and  $10\mu\text{m}$ , and
    - the hydrophilic reaction layer being a hydrogel, the hydrogel including a cross-linking agent.

2.-4. (CANCELLED)

5. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 1, wherein the microelectrode arrangement is a two-pole system, and wherein the reaction layer has a thickness of approximately 3  $\mu\text{m}$ .
6. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 1, wherein the microelectrode arrangement is a four-pole system, and wherein the reaction layer has a thickness of approximately 7  $\mu\text{m}$ .
7. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 1, wherein the reaction layer is thermally stable up to approximately 95°C.
8. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 1, wherein the reaction layer contains coupling groups for the covalent binding of catcher molecules.
9. (CANCELLED)
10. (CURRENTLY AMENDED) The DNA chip as claimed in claim 6, wherein the hydrophilic reaction layer is an acrylamide-based radical-crosslinkable hydrogel includes—including at least one of maleic anhydride and glycidyl (meth)acrylate as coupling groups.

11. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 1, wherein the electrode arrangement is an interdigital electrode arrangement.

12. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 11, wherein the interdigital electrode arrangement is a two-pole microelectrode system.

13. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 11, wherein the interdigital electrode arrangement is a four-pole microelectrode system.

14. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 1, wherein the flat carrier includes a semiconductor layer and an insulating layer connected thereto, the insulating layer carrying the electrode arrangement and the reaction layer on its side remote from the semiconductor layer.

15. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 14, wherein the semiconductor layer is a silicon layer.

16.-20. (CANCELLED)

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END OF CLAIM LISTING